

REVISIONS

LTR	DESCRIPTION	DATE (YR-MO-DA)	APPROVED
A	Delete CAGE 01295 from 8512601BX. Add CAGE 04713 to approved source list. Delete V <sub>OH</sub> test; add to recommended operating conditions. Change t <sub>PLH</sub> (10, 11) in table I. Table I, prop. delays, add "A or B to Y". Prop. delay: Change R <sub>L</sub> . Revise to military drawing format. Delete I <sub>OL</sub> test in table I.	87-12-31	M. A. Frye
B	Add device type 02. Add figure 3: Test circuit and switching waveforms. Update the boilerplate.	92-09-11	M. L. Poelking
C	Update to current requirements. Editorial changes throughout. - gap	05-12-15	Raymond Monnin
D	Update drawing to current MIL-PRF-38535 requirements. - jt	17-11-03	Charles Saffle
E	Update drawing to latest MIL-PRF-38535 requirements. - jt	22-07-25	James R. Eschmeyer



Current CAGE code is 67268

THE ORIGINAL FIRST SHEET OF THIS DRAWING HAS BEEN REPLACED.

Revision Status of Sheets

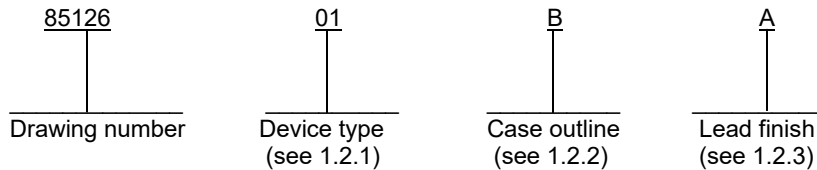
REV																				
SHEET																				
REV	E	E	E	E	E	E	E	E	E	E										
SHEET	1	2	3	4	5	6	7	8	9	10										

PMIC N/A		PREPARED BY Monica L. Grosel		DLA LAND AND MARITIME COLUMBUS, OHIO 43218-3990 <a href="https://www.dla.mil/LandandMaritime">https://www.dla.mil/LandandMaritime</a>			
<b>STANDARD MICROCIRCUIT DRAWING</b>		CHECKED BY Robert P. Evans					
		APPROVED BY Michael A. Frye					
		DRAWING APPROVAL DATE 85-05-13					
THIS DRAWING IS AVAILABLE FOR USE BY ALL DEPARTMENTS AND AGENCIES OF THE DEPARTMENT OF DEFENSE		MICROCIRCUIT, DIGITAL ,BIPOLAR LOW- POWER SCHOTTKY TTL, BUFFERS, MONOLITHIC SILICON					
AMSC N/A		REVISION LEVEL E		SIZE A	CAGE CODE 14933	85126	
				SHEET		1 OF 10	

1. SCOPE

1.1 Scope. This drawing describes device requirements for MIL-STD-883 compliant, non-JAN class level B microcircuits in accordance with MIL-PRF-38535, appendix A.

1.2 Part or Identifying Number (PIN). The complete PIN is as shown in the following example:



1.2.1 Device type. The device type identify the circuit function as follows:

<u>Device type</u>	<u>Generic number</u>	<u>Circuit function</u>
01	54LS33	Quadruple two-input positive NOR buffers with open collector outputs
02	54LS28	Quadruple two-input positive NOR buffers

1.2.2 Case outlines. The case outlines are as designated in MIL-STD-1835 and as follows:

<u>Outline letter</u>	<u>Descriptive designator</u>	<u>Terminals</u>	<u>Package style</u>
B	GDFP4-F14	14	flat pack
C	GDIP1-T14	14	dual-in-line
D	GDFP1-F14	14	flat pack
2	CQCC1-N20	20	square chip carrier

1.2.3 Lead finish. The lead finish is as specified in MIL-PRF-38535, appendix A.

1.3 Absolute maximum ratings.

Supply voltage range .....	-0.5 V dc to +7.0 V dc
Input voltage range .....	-1.5 V dc at -18 mA to +7.0 V dc
Storage temperature range .....	-65°C to +150°C
Lead temperature (soldering, 10 seconds) .....	+300°C
Junction temperature (T <sub>J</sub> ) .....	+175°C
Maximum power dissipation (P <sub>D</sub> ) per device <sup>1/</sup> .....	75.9 mW
Thermal resistance, junction-to-case (θ <sub>JC</sub> ) .....	See MIL-STD-1835

1.4 Recommended operating conditions.

Supply voltage range (V <sub>CC</sub> ) .....	4.5 V dc minimum to 5.5 V dc maximum
Maximum high level output voltage (V <sub>OH</sub> ) (type 01) .....	5.5 V dc
Minimum high level input voltage (V <sub>IH</sub> ) .....	2.0 V dc
Maximum low level input voltage (V <sub>IL</sub> ) .....	0.7 V dc
Maximum high level output current (I <sub>OH</sub> ) (type 02) .....	-1.2 mA
Maximum low level output current (I <sub>OL</sub> ) .....	12 mA
Case operating temperature range (T <sub>C</sub> ) .....	-55°C to +125°C

<sup>1/</sup> Maximum power dissipation is defined as V<sub>CC</sub> x I<sub>CC</sub>. Must withstand the added P<sub>D</sub> due to short circuit test (e.g. I<sub>OS</sub>).

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		REVISION LEVEL <b>E</b>	SHEET <b>2</b>

## 2. APPLICABLE DOCUMENTS

2.1 Government specification, standards, and handbooks. The following specification, standards, and handbooks form a part of this drawing to the extent specified herein. Unless otherwise specified, the issues of these documents are those cited in the solicitation or contract.

### DEPARTMENT OF DEFENSE SPECIFICATION

MIL-PRF-38535 - Integrated Circuits, Manufacturing, General Specification for.

### DEPARTMENT OF DEFENSE STANDARDS

MIL-STD-883 - Test Method Standard Microcircuits.  
MIL-STD-1835 - Interface Standard Electronic Component Case Outlines.

### DEPARTMENT OF DEFENSE HANDBOOKS

MIL-HDBK-103 - List of Standard Microcircuit Drawings.  
MIL-HDBK-780 - Standard Microcircuit Drawings.

(Copies of these documents are available online at <https://quicksearch.dla.mil/>.)

2.2 Order of precedence. In the event of a conflict between the text of this drawing and the references cited herein, the text of this drawing takes precedence. Nothing in this document, however, supersedes applicable laws and regulations unless a specific exemption has been obtained.

## 3. REQUIREMENTS

3.1 Item requirements. The individual item requirements shall be in accordance with MIL-PRF-38535, appendix A for non-JAN class level B devices and as specified herein. Product built to this drawing that is produced by a Qualified Manufacturer Listing (QML) certified and qualified manufacturer or a manufacturer who has been granted transitional certification to MIL-PRF-38535 may be processed as QML product in accordance with the manufacturers approved program plan and qualifying activity approval in accordance with MIL-PRF-38535. This QML flow as documented in the Quality Management (QM) plan may make modifications to the requirements herein. These modifications shall not affect form, fit, or function of the device. These modifications shall not affect the PIN as described herein. A "Q" or "QML" certification mark in accordance with MIL-PRF-38535 is required to identify when the QML flow option is used.

3.2 Design, construction, and physical dimensions. The design, construction, and physical dimensions shall be as specified in MIL-PRF-38535, appendix A and herein.

3.2.1 Case outlines. The case outlines shall be in accordance with 1.2.2 herein.

3.2.2 Terminal connections. The terminal connections shall be as specified on figure 1.

3.2.3 Truth table. The truth table shall be as specified on figure 2.

3.2.4 Test circuit and switching waveforms. The test circuit and switching waveforms shall be as specified on figure 3.

3.3 Electrical performance characteristics. Unless otherwise specified herein, the electrical performance characteristics are as specified in table I and shall apply over the full case operating temperature range.

3.4 Electrical test requirements. The electrical test requirements shall be the subgroups specified in table II. The electrical tests for each subgroup are described in table I.

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3.5 Marking. Marking shall be in accordance with MIL-PRF-38535, appendix A. The part shall be marked with the PIN listed in 1.2 herein. In addition, the manufacturer's PIN may also be marked.

3.5.1 Certification/compliance mark. A compliance indicator "C" shall be marked on all non-JAN devices built in compliance to MIL-PRF-38535, appendix A. The compliance indicator "C" shall be replaced with a "Q" or "QML" certification mark in accordance with MIL-PRF-38535 to identify when the QML flow option is used.

3.6 Certificate of compliance. A certificate of compliance shall be required from a manufacturer in order to be listed as an approved source of supply in MIL-HDBK-103 (see 6.6 herein). The certificate of compliance submitted to DLA Land and Maritime-VA prior to listing as an approved source of supply shall affirm that the manufacturer's product meets the requirements of MIL-PRF-38535, appendix A and the requirements herein.

3.7 Certificate of conformance. A certificate of conformance as required in MIL-PRF-38535, appendix A shall be provided with each lot of microcircuits delivered to this drawing.

3.8 Notification of change. Notification of change to DLA Land and Maritime-VA shall be required for any change that affects this drawing.

3.9 Verification and review. DLA Land and Maritime, DLA Land and Maritime's agent, and the acquiring activity retain the option to review the manufacturer's facility and applicable required documentation. Offshore documentation shall be made available onshore at the option of the reviewer.

#### 4. VERIFICATION

4.1 Sampling and inspection. Sampling and inspection procedures shall be in accordance with MIL-PRF-38535, appendix A.

4.2 Screening. Screening shall be in accordance with method 5004 of MIL-STD-883, and shall be conducted on all devices prior to quality conformance inspection. The following additional criteria shall apply:

a. Burn-in test, method 1015 of MIL-STD-883.

(1) Test condition A, B, C or D. The test circuit shall be maintained by the manufacturer under document revision level control and shall be made available to the preparing or acquiring activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in method 1015 of MIL-STD-883.

(2)  $T_A = +125^{\circ}\text{C}$ , minimum.

b. Interim and final electrical test parameters shall be as specified in table II herein, except interim electrical parameter tests prior to burn-in are optional at the discretion of the manufacturer.

4.3 Quality conformance inspection. Quality conformance inspection shall be in accordance with method 5005 of MIL-STD-883 including groups A, B, C, and D inspections. The following additional criteria shall apply.

##### 4.3.1 Group A inspection.

a. Tests shall be as specified in table II herein.

b. Subgroups 4, 5, 6 and 8 in table I, method 5005 of MIL-STD-883 shall be omitted.

c. Subgroups 7 shall include verification of the truth table.

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TABLE I. Electrical performance characteristics.

Test	Symbol	Conditions -55°C ≤ T <sub>C</sub> ≤ +125°C 4.5 V ≤ V <sub>CC</sub> ≤ 5.5 V unless otherwise specified		Group A subgroups	Device type	Limits		Unit
						Min	Max	
High level output voltage	V <sub>OH</sub>	V <sub>CC</sub> = 4.5 V, V <sub>IL</sub> = 0.7 V, I <sub>OH</sub> = -1.2 mA		1, 2, 3	02	2.5		V
Low level output voltage	V <sub>OL</sub>	V <sub>CC</sub> = 4.5 V, V <sub>IH</sub> = 2.0 V, I <sub>OL</sub> = 12 mA, V <sub>IL</sub> = 0.7 V		1, 2, 3	All		0.4	V
Input clamp voltage	V <sub>IC</sub>	V <sub>CC</sub> = 4.5 V, I <sub>IN</sub> = -18 mA, T <sub>C</sub> = +25°C		1	All		-1.5	V
High level output current	I <sub>OH</sub>	V <sub>CC</sub> = 4.5 V, V <sub>IH</sub> = 2.0 V, V <sub>OUT</sub> = 5.5 V, V <sub>IL</sub> = 0.7 V		1, 2, 3	01		250	μA
High level input current	I <sub>IH1</sub>	V <sub>CC</sub> = 5.5 V, V <sub>IH</sub> = 7.0 V		1, 2, 3	All		100	μA
	I <sub>IH2</sub>	V <sub>CC</sub> = 5.5 V, V <sub>IH</sub> = 2.7 V		1, 2, 3			20	
Low level input current	I <sub>IL</sub>	V <sub>CC</sub> = 5.5 V, V <sub>IL</sub> = 0.4 V		1, 2, 3	All		-0.4	mA
Short-circuit output current <u>1/</u>	I <sub>OS</sub>	V <sub>CC</sub> = 5.5 V		1, 2, 3	02	-30	-130	mA
Supply current	I <sub>CCH</sub>	V <sub>CC</sub> = 5.5 V, V <sub>IN</sub> = 0.0 V	Outputs high	1, 2, 3	All		3.6	mA
	I <sub>ACL</sub>	V <sub>CC</sub> = 5.5 V, V <sub>IN</sub> = 4.5 V	Outputs low	1, 2, 3			13.8	

See footnotes at end of table.

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TABLE I. Electrical performance characteristics - Continued.

Test	Symbol	Conditions -55°C ≤ T <sub>A</sub> ≤ +125°C 4.5 V ≤ V <sub>CC</sub> ≤ 5.5 V unless otherwise specified	Group A subgroups	Device type	Limits		Unit
					Min	Max	
Functional testing		See 4.3.1c	7	All			
Propagation delay time, A or B to Q	t <sub>PLH</sub>	V <sub>CC</sub> = 5.0 V, R <sub>L</sub> = 667 Ω ±5%,  C <sub>L</sub> = 50 pF ±10%  <u>2/</u>	9	01		32	ns
				02		24	
			10, 11	01		45	
				02		34	
	t <sub>PHL</sub>		9	01		28	
				02		34	
			10, 11	01		39	
				02		34	

1/ Not more than one output should be shorted at a time and the duration of the short circuit should not exceed 1 second.

2/ Propagation delay time testing may be done using either R<sub>L</sub> = 667 Ω or R<sub>L</sub> = 2 kΩ.

**STANDARD  
MICROCIRCUIT DRAWING**  
DLA LAND AND MARITIME  
COLUMBUS, OHIO 43218-3990

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Device types	01 and 02	
Case outlines	B, C, and D	2
Terminal number	Terminal symbols	
1	1Y	NC
2	1A	1Y
3	1B	1A
4	2Y	1B
5	2A	NC
6	2B	2Y
7	GND	NC
8	3A	2A
9	3B	2B
10	3Y	GND
11	4A	NC
12	4B	3A
13	4Y	3B
14	V <sub>cc</sub>	3Y
15		NC
16		4A
17		NC
18		4B
19		4Y
20		V <sub>cc</sub>

NC = No connection

FIGURE 1. Terminal connections.

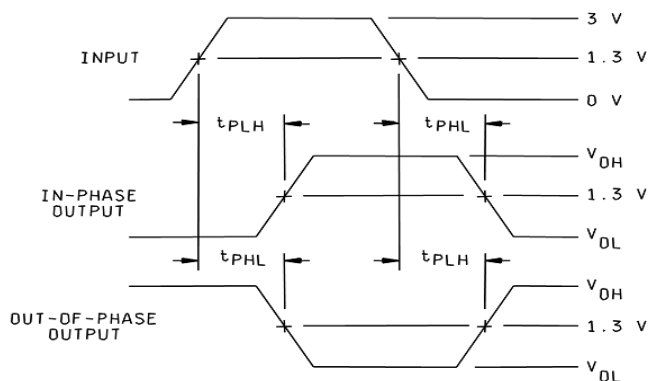
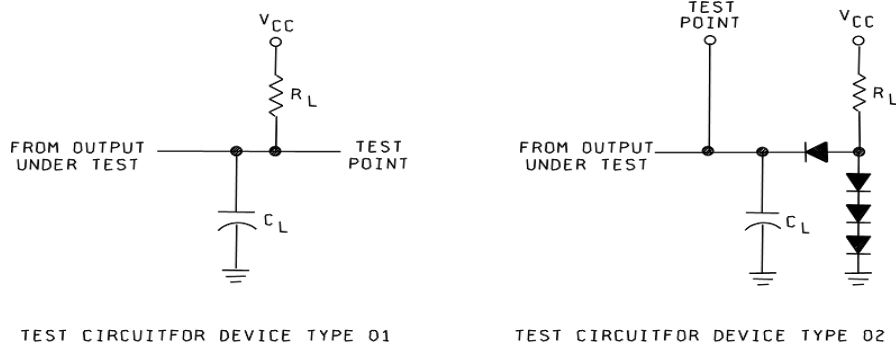
Device types 01 and 02

Inputs		Output
A	B	Y
L	L	H
L	H	L
H	L	L
H	H	L

H = High level voltage  
L = Low level voltage

FIGURE 2. Truth table.

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NOTES:

1.  $C_L$  includes probe and jig capacitance.
2. All diodes are 1N3064 or equivalent.
3. All input pulses have the following characteristics:  $PRR \leq 1 \text{ MHz}$ ,  $Z_{OUT} \approx 50 \Omega$ ,  $t_r \leq 15 \text{ ns}$ ,  $t_f \leq 6 \text{ ns}$ .
4. The outputs are measured one at a time with one input transition per measurement

FIGURE 3. Test circuit and switching waveforms.

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TABLE II. Electrical test requirements.

MIL-STD-883 test requirements	Subgroups (in accordance with MIL-STD-883, method 5005, table I)
Interim electrical parameters (method 5004)	---
Final electrical test parameters (method 5004)	1*, 2, 3, 9
Group A test requirements (method 5005)	1, 2, 3, 7, 9, 10**, 11**
Groups C and D end-point electrical parameters (method 5005)	1, 2, 3

\* PDA applies to subgroup 1.

\*\* Subgroup 10 and 11, if not tested, shall be guaranteed to the specified limits in table I.

4.3.2 Groups C and D inspections.

- a. End-point electrical parameters shall be as specified in table II herein.
- b. Steady-state life test conditions, method 1005 of MIL-STD-883.
  - (1) Test condition A, B, C, or D. The test circuit shall be maintained by the manufacturer under document revision level control and shall be made available to the preparing or acquiring activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in method 1005 of MIL-STD-883.
  - (2)  $T_A = +125^\circ\text{C}$ , minimum.
  - (3) Test duration: 1,000 hours, except as permitted by method 1005 of MIL-STD-883.

5. PACKAGING

5.1 Packaging requirements. The requirements for packaging shall be in accordance with MIL-PRF-38535, appendix A.

6. NOTES

6.1 Intended use. Microcircuits conforming to this drawing are intended for use for Government microcircuit applications (original equipment), design applications, and logistics purposes.

6.2 Replaceability. Microcircuits covered by this drawing will replace the same generic device covered by a contractor-prepared specification or drawing.

6.3 Configuration control of SMD's. All proposed changes to existing SMD's will be coordinated with the users of record for the individual documents. This coordination will be accomplished using DD Form 1692, Engineering Change Proposal.

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6.4 Record of users. Military and industrial users shall inform DLA Land and Maritime when a system application requires configuration control and the applicable SMD to that system. DLA Land and Maritime will maintain a record of users and this list will be used for coordination and distribution of changes to the drawings. Users of drawings covering microelectronics devices (FSC 5962) should contact DLA Land and Maritime -VA, telephone (614) 692-8108.

6.5 Comments. Comments on this drawing should be directed to DLA Land and Maritime -VA, Columbus, Ohio 43218-3990, or telephone (614) 692-0591.

6.6 Approved sources of supply. Approved sources of supply are listed in MIL-HDBK-103 and QML-38535. The vendors listed in MIL-HDBK-103 and QML-38535 have agreed to this drawing and a certificate of compliance (see 3.6 herein) has been submitted to and accepted by DLA Land and Maritime -VA.

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STANDARD MICROCIRCUIT DRAWING BULLETIN

DATE: 22-07-25

Approved sources of supply for SMD 85126 are listed below for immediate acquisition information only and shall be added to MIL-HDBK-103 and QML-38535 during the next revision. MIL-HDBK-103 and QML-38535 will be revised to include the addition or deletion of sources. The vendors listed below have agreed to this drawing and a certificate of compliance has been submitted to and accepted by DLA Land and Maritime-VA. This information bulletin is superseded by the next dated revision of MIL-HDBK-103 and QML-38535. DLA Land and Maritime maintains an online database of all current sources of supply at <https://landandmaritimeapps.dla.mil/programs/smcr/>.

Standard microcircuit drawing PIN 1/	Vendor CAGE number	Vendor similar PIN 2/
8512601BA	58625	SL54LS33/BBA
8512601CA	01295	SNJ54LS33J
	58625	SL54LS33/BCA
8512601DA	01295	SNJ54LS33W
	58625	SL54LS33/BDA
85126012A	3/	SNJ54LS33FK
	58625	SL54LS33/B2A
85126012C	58625	SL54LS33/B2C
8512602BA	0DKS7	GEM18802QBA
8512602BC	0DKS7	GEM18802QBC
8512602CA	0DKS7	GEM18802QCA
8512602CC	0DKS7	GEM18802QCC
8512602DA	0DKS7	GEM18802QDA
8512602DC	0DKS7	GEM18802QDC
85126022A	0DKS7	GEM18802Q2A
85126022C	0DKS7	GEM18802Q2C

1/ The lead finish shown for each PIN representing a hermetic package is the most readily available from the manufacturer listed for that part. If the desired lead finish is not listed contact the vendor to determine its availability.

2/ Caution. Do not use this number for item acquisition. Items acquired to this number may not satisfy the performance requirements of this drawing.

3/ Not available from an approved source of supply.

STANDARD MICROCIRCUIT DRAWING BULLETIN – Continued.

DATE: 22-07-25

<u>Vendor CAGE number</u>	<u>Vendor name and address</u>
01295	Texas Instruments, Inc. Semiconductor Group 8505 Forest Ln. P.O. Box 660199 Dallas, TX 75243
58625	Lansdale Semiconductor, Inc. 5245 S. 39 <sup>th</sup> St. Phoenix, AZ 85040-9008
ODKS7	SRI International 201 Washington Road Princeton, NJ 08540-6449

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